

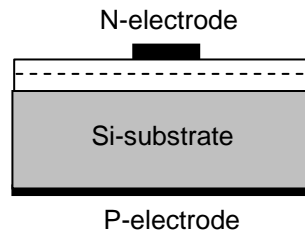
### > Mechanical Specification:

#### (1) Dimension

- Chip size: 20 mil x 20 mil ( $500\pm 25\ \mu\text{m}$  x  $500\pm 25\ \mu\text{m}$ )
- Thickness: 8.8 mil ( $225\pm 25\ \mu\text{m}$ )
- N bonding pad: 3.9 mil ( $100\pm 10\ \mu\text{m}$ )

#### (2) Metallization

- Topside N electrode : Au alloy
- Backside P electrode: Au alloy



#### Features:

- High radiant flux
- Thin film structure
- Vertical electrode
- High driving current

#### Applications:

- Horticulture lighting
- Medical appliances

### > Electro-optical Characteristics at 25°C:

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	Vf1	If = 10 $\mu$ A	1.3	-	-	V
	Vf2	If = 150mA	-	2.2	2.6	V
Reverse Current	Ir	Vr = 10V	-	-	5.0	$\mu$ A
Peak Wavelength <sup>(1)</sup>	$\lambda_p$	If = 150mA	650	660	670	nm
Spectra Half-width	$\Delta\lambda$	If = 150mA	-	20	-	nm
Radiant flux <sup>(2)(3)</sup>	Po	H5	85	-	-	mW
		H6	100	-	-	

Note:

(1) Basically, the wavelength span is 20nm; however, customers' special requirements are also welcome.

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(3) Radiant flux is measured by EPISTAR's equipment on bare chips.

## > Absolute Maximum Ratings:

Parameter	Symbol	Condition	Rating	Unit
Forward DC Current	$I_f$	$T_a = 25^\circ\text{C}$	$\leq 180$	mA
Reverse Voltage	$V_r$	$T_a = 25^\circ\text{C}$	$\leq 10$	V
Junction Temperature	$T_j$	-	$\leq 115$	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	Chip	$-40 \sim +85$	$^\circ\text{C}$
		Chip-on-tape/storage	$5 \sim 35$	$^\circ\text{C}$
		Chip-on-tape/transportation	$-20 \sim +65$	$^\circ\text{C}$
Temperature during Packaging	-	-	$280(<10\text{sec})$	$^\circ\text{C}$

Note: Maximum ratings are package dependent. The above maximum ratings were determined using a Metal Core Printed Circuit Board (MCPCB) without an encapsulant. Stresses in excess of the absolute maximum ratings such as forward current and junction temperature may cause damage to the LED.

## > Characteristic Curves:

Fig.1 – Relative Radiant Flux vs. Forward Current

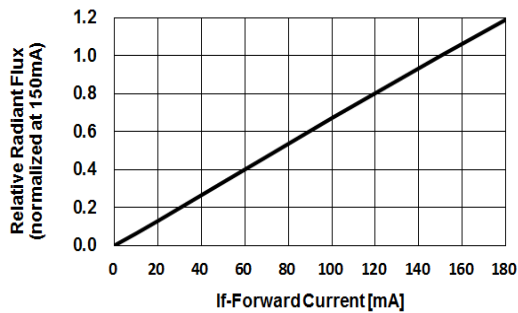


Fig.2 – Forward Current vs. Forward Voltage

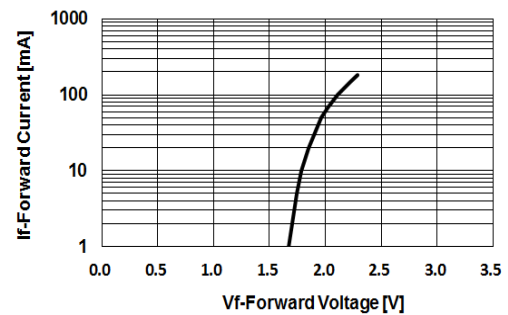


Fig.3 – Relative Radiant Flux (@150mA) vs. Ambient Temperature

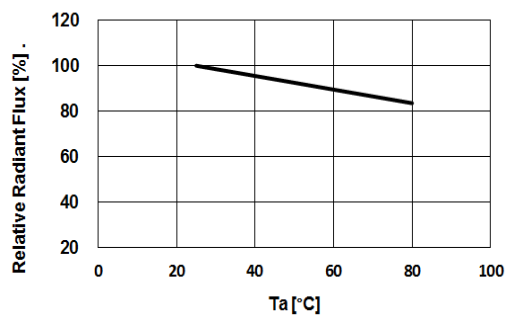


Fig.4 – Forward Voltage (@150mA) vs. Ambient Temperature

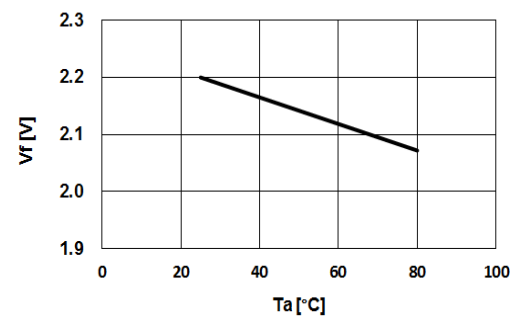


Fig.5 – Peak Wavelength (@150mA) vs. Ambient Temperature

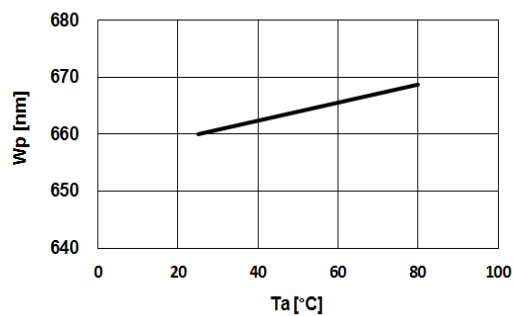


Fig.6 – Maximum Driving Forward DC Current vs. Ambient Temperature (De-rating based on  $T_j \text{ max.} = 115^\circ\text{C}$ )

